



10-Bit, 75 MSPS TTL A/D Converter

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65E D

AD9060

1.1 Scope.

This specification covers the requirements for a flash 10-bit, 75 MspS TTL analog-to-digital converter (ADC). Refer to the commercial data sheet for applications information.

1.2 Part Number.

The complete part number per Table 1 of this specification is as follows:

Device	Part Number
-1	AD9060S(X)/883B
-2	AD9060T(X)/883B

1.2.3 Case Outline.

See Appendix 1 of General Specification ADI-M-1000: package outline:

(X)	Package	Description
E	E-68A	68-Pin Leadless Ceramic Chip Carrier
Z	Z-68	68-Pin Leaded Ceramic Chip Carrier

1.3 Absolute Maximum Ratings. ($T_A = +25^\circ\text{C}$ unless otherwise noted)

Positive Supply Voltage ($+V_S$)	+6 V
Negative Supply Voltage ($-V_S$)	-6 V
Analog Input Voltage	-2 V to +2 V
$+V_{REF}$, $-V_{REF}$, $3/4_{REF}$, $1/2_{REF}$, $1/4_{REF}$	-2 V to +2 V
$+V_{REF}$ to $-V_{REF}$	4.0 V
ENCODE, $\overline{\text{ENCODE}}$	0 V to $-V_S$
$3/4_{REF}$, $1/2_{REF}$, $1/4_{REF}$ Current	± 10 mA
Digital Output Current	20 mA
Operating Temperature Range (Case)	-55°C to $+125^\circ\text{C}$
Junction Temperature	$+175^\circ\text{C}$
Storage Temperature Range (Case)	-65°C to $+150^\circ\text{C}$
Lead Soldering Temperature (10 sec)	$+300^\circ\text{C}$

1.5 Thermal Characteristics.

Maximum junction temperature should not be allowed to exceed $+175^\circ\text{C}$. Typical thermal impedances (part soldered onto board):

- 68-pin leaded ceramic chip carrier: $\theta_{JC} = 1^\circ\text{C}/\text{W}$; $\theta_{JA} = 17^\circ\text{C}/\text{W}$ (no air flow);
 $\theta_{JA} = 15^\circ\text{C}/\text{W}$ (air flow = 500 LFPM)
- 68-pin ceramic LCC: $\theta_{JC} = 2.6^\circ\text{C}/\text{W}$; $\theta_{JA} = 15^\circ\text{C}/\text{W}$ (no air flow);
 $\theta_{JA} = 13^\circ\text{C}/\text{W}$ (air flow = 500 LFPM).

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Table 1.

Test	Symbol	Device	Design Limits ¹	Sub Group 1	Sub Group 2, 3	Sub Group 4	Sub Group 7	Sub Group 8	Sub Group 9	Test Conditions ²	Units
Differential Nonlinearity	DNL	-1					1.25	1.5		See Note 3	LSB
							1.0	1.25			
Integral Nonlinearity	INL	-1					2.0	2.5		See Note 3	LSB
		-2					1.5	2.0			
No Missing Codes		All					Guaranteed See Note 3				
Input Bias Current	I_B	All		1	2					See Note 4	mA max
Input Resistance	R_I	All		2.0							k Ω min
Reference Ladder Resistance	R_{RL}	All		22	14						Ω min
				56	66						
Reference Ladder Offset (Top)	O_{RLT}	All					90	90			mV max
Reference Ladder Offset (Bottom)	O_{RLB}	All					90	90			mV max
Maximum Conversion Rate		All				75					Msp/s min
Output Delay	t_{OD}	All							2	See Note 5	ns min
									9		ns max
Output Time Skew	t_{OTS}	All							3	See Note 5	ns max
Rise Time	t_R	All							3		ns max
Fall Time	t_F	All							3		ns max
Encode Pulse Voltage (HIGH)	$V_{E(H)}$	All		-1.1	-1.1						V min
Encode Pulse Voltage (LOW)	$V_{E(L)}$	All		-1.5	-1.5						V max
Encode Pulse Current (HIGH)	$I_{E(H)}$	All		300	300						μ A max
Encode Pulse Current (LOW)	$I_{E(L)}$	All		300	300						μ A max
Encode Pulse Width (HIGH)	$t_{E(H)}$	All				6					ns min
Encode Pulse Width (LOW)	$t_{E(L)}$	All				6					ns min
Effective Number of Bits	ENOB	All					8.7			$A_{IN} = 2.3$ MHz	Bits min
Signal-to-Noise Ratio ⁶	SNR	All					54			$A_{IN} = 2.3$ MHz	dB min
										$A_{IN} = 10.3$ MHz	dB min
										$A_{IN} = 15.3$ MHz	
Signal-to-Noise Ratio ⁷	SNR	All					54			$A_{IN} = 2.3$ MHz	dB min
										$A_{IN} = 10.3$ MHz	dB
										$A_{IN} = 15.3$ MHz	dB min
Harmonic Distortion	HD	All					61			$A_{IN} = 2.3$ MHz	dBc min
										$A_{IN} = 10.3$ MHz	dBc min
										$A_{IN} = 15.3$ MHz	min
High Level Output Voltage	V_{OH}	All		-1.1	-1.1						V min
Low Level Output Voltage	V_{OL}	All		-1.5	-1.5						V max
+ V_S Supply Current	+ I_S	All		500	500						mA max
- V_S Supply Current	- I_S	All		180	190						mA max
Power Dissipation	- I_S	All		3.3	3.5						W max
Power Supply Rejection Ratio	PSRR	All					10	10			mV/V max

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NOTES

¹Value shown is over full temperature range. Number in this column indicates specification is guaranteed but not tested.

² $\pm V_S = \pm 5 \text{ V}$; $\pm V_{\text{SENSE}} = \pm 1.75 \text{ V}$; ENCODE = 40 Msp, unless otherwise indicated.

³3/4 REF, 1/2 REF, and 1/4 REF reference ladder taps are driven from dc sources at +0.875 V, 0 V, and -0.875 V, respectively. Accuracy of the overflow comparator is not tested and is not included in linearity specifications.

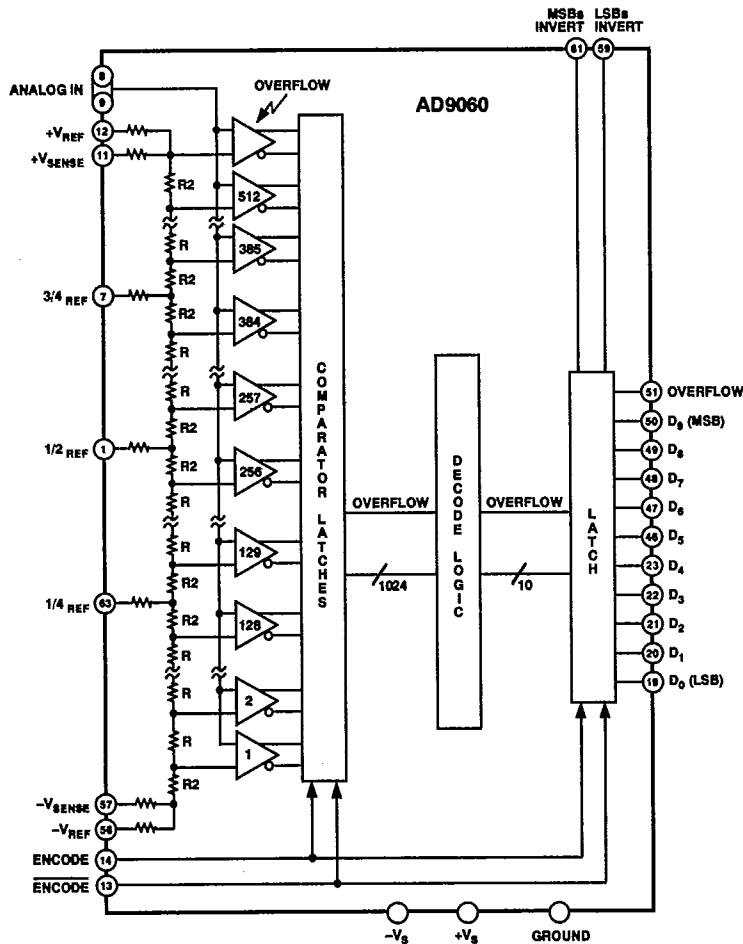
⁴Measured with ANALOG IN = $+V_{\text{SENSE}}$.

⁵Output delay measured as worst-case time from 50% point of the rising edge of ENCODE to 50% point of the slowest rising or falling edge of D0-D9. Output skew measured as worst-case difference in output delay among D0-D9.

⁶RMS signal to rms noise, including harmonics, with analog input signal 1 dB below full scale at specified frequency.

⁷RMS signal to rms noise, without harmonics, with analog input signal 1 dB below full scale at specified frequency.

3.2.1 Functional Block Diagram and Terminal Assignments.



3.2.4 Microcircuit Technology Group.

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This microcircuit is covered by technology group (D-57).

4.2.1 Life Test/Burn-In Circuit.

Steady state life test is per MIL-STD-883 Method 1005. Burn-in is per MIL-STD-883 Method 1015 test condition (B).

